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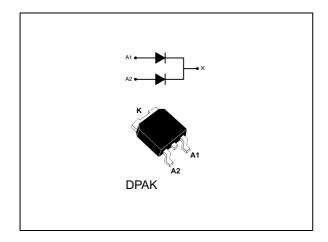


life.augmented

STPS15L45C-Y

Automotive low drop power Schottky rectifier

Datasheet - production data



Description

Dual center tab Schottky rectifier suited for Switch Mode Power Supply and high frequency DC to DC converters.

Package in DPAK, this device is intended for use in low voltage, high frequency inverters, free-wheeling and polarity protection for automotive application.

Features

- Very small conduction losses
- · Negligible switching losses
- · Extremely fast switching
- Low forward voltage drop
- Avalanche capability specified
- AEC-Q101 qualified

Table 1. Device summary

Symbol	Value
I _{F(AV)}	2 x 7.5 A
V_{RRM}	45 V
T _j (max.)	150 °C
V _f (max.)	0.46 V

Characteristics STPS15L45C-Y

1 Characteristics

Table 2. Absolute Ratings (limiting values)

Symbol	Parameter	Value	Unit		
V_{RRM}	Repetitive peak reverse voltage	45	V		
I _{F(RMS)}	Forward rms voltage			10	Α
I _{F(AV)}	Average forward current $T_c = 140 ^{\circ}\text{C}$ Per diode $\delta = 0.5$ Per device				Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms si	nusoidal	75	Α
I _{RRM}	Peak repetitive reverse current	t _p = 2 μs squ F = 1 kHz	are	1	Α
P _{ARM}	Repetitive peak avalanche power	t _p = 10 μs	T _j = 125 °C	266	W
T _{stg}	Storage temperature range			-65 to +175	°C
Tj	Maximum operating junction temperature range ⁽¹⁾				°C
dV/dt	Critical rate of rise of reverse voltage				V/µs

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit	
R _{th(j-c)}	Junction to case	Per diode Total	4 2.4	°C/W
R _{th(c)}	Coupling	ng .		

When the diodes 1 and 2 are used simultaneously:

 $\Delta T_{j}(\text{diode 1}) = P(\text{diode 1}) \times R_{\text{th(j-c)}}(\text{Per diode}) + P(\text{diode 2}) \times R_{\text{th(c)}}$

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾ Reverse leakage current	Poverse leakage current	T _j = 25 °C	\/ -\/	-		1	mA
	T _j = 125 °C	$V_R = V_{RRM}$	-	23	45	mA	

STPS15L45C-Y Characteristics

Symbol	Parameter	Test co	Min.	Тур.	Max.	Unit	
	V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 7.5 A	-		0.52	
		T _j = 125 °C	I _F = 7.5 A	-	0.40	0.46	,
V (1)		T _j = 25 °C	I _F = 12 A	-		0.60	V
VF` ′		T _j = 125 °C	I _F = 12 A	-	0.49	0.57	V
		T _j = 25 °C	I _F = 15 A	-		0.64	
		T _j = 125 °C	I _F = 15 A	-	0.53	0.63	

Table 4. Static electrical characteristics (continued)

To evaluate the conduction losses use the following equation:

$$P = 0.29 \times I_{F(AV)} + 0.023 I_{F}^{2}(RMS)$$

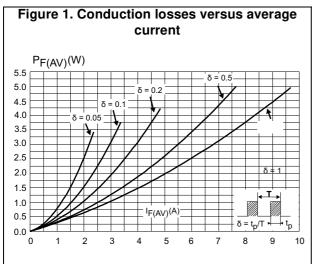


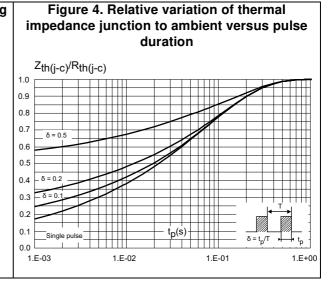
Figure 3. Normalized avalanche power derating versus pulse duration

1 PARM(tp)/PARM(10 µs)

0.01

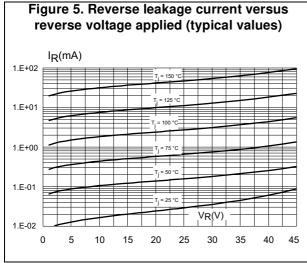
0.001

1 10 100 1000



^{1.} Pulse test: t_p = 380 μ s, δ < 2%

Characteristics STPS15L45C-Y



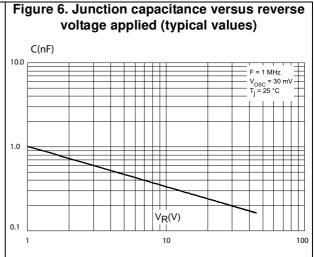


Figure 7. Forward voltage drop versus forward current

IFM(A)

100

T_j=125 'C

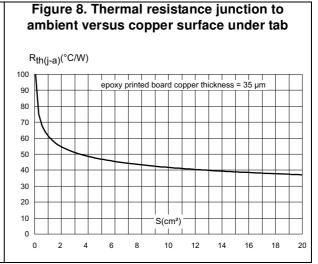
(Maximum values)

T_j=25 'C

(Maximum values)

V_{FM}(V)

1 0.0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8

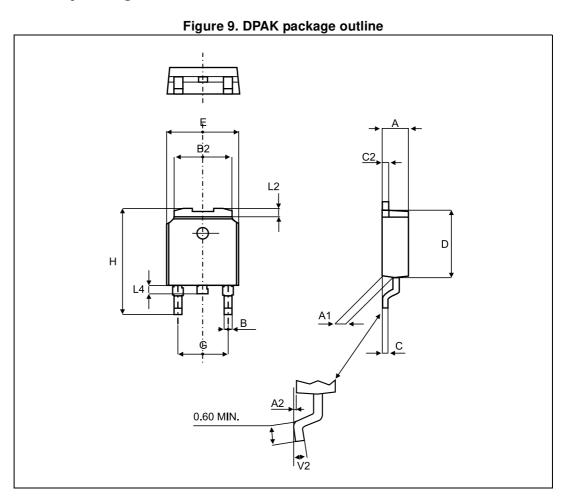


2 Package information

- Epoxy meets UL94, V0
- · Lead-free packages

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2.1 DPAK package information



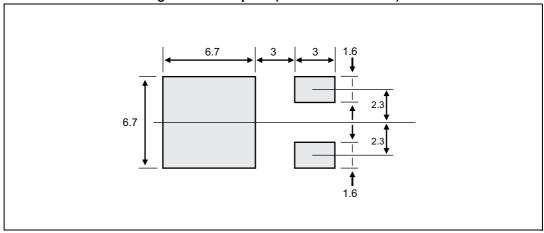
Package information STPS15L45C-Y

Table 5. DPAK package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches ⁽¹⁾	
	Тур.	Min.	Max.	Тур.	Min.	Max.
Α		2.20	2.40		0.086	0.094
A1		0.90	1.10		0.035	0.043
A2		0.03	0.23		0.001	0.009
В		0.64	0.90		0.025	0.035
B2		5.20	5.40		0.204	0.212
С		0.45	0.60		0.017	0.023
C2		0.48	0.60		0.018	0.023
D		6.00	6.20		0.236	0.244
E		6.40	6.60		0.251	0.259
G		4.40	4.60		0.173	0.181
Н		9.35	10.10		0.368	0.397
L2	0.80			0.031		
L4		0.60	1.00		0.023	0.039
V2		0°	8°		0°	8°

^{1.} Values in inches are converted from mm and rounded to 4 decimal digits.

Figure 10. Footprint (dimensions in mm)



3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS15L45CBY-TR	S15L45CY	DPAK	0.30 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
10-Mar-2011	1	First issue.
07-Jul-2015	2	Updated <i>Table 2</i> . Format updated to current standard.

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